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DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

Attorney Docket No. 5649-1123IP

I, a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **Post Thermal Treatment Methods of Forming High Dielectric Layers Over Interfacial Layers in Integrated Circuit Devices**, the specification of which

☐ is attached hereto

OR

☒ was filed on September 10, 2003 as United States Application No.10/659,945 or PCT International Application Number _____ and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37 Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate, or of any PCT International application having a filing date before that of the application on which priority is claimed.

02-54606	Korea	09/10/2002	[X] Yes [] No
Number	Country	MM/DD/YYYY Filed	Priority Claimed
02-61702	Korea	09/04/2003	[X] Yes [] No
Number	Country	MM/DD/YYYY Filed	Priority Claimed
			[] Yes [] No
Number	Country	MM/DD/YYYY Filed	Priority Claimed

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) or § 365(c) of any PCT international application designating the United States of America, listed below.

10/650,415	08/29/2003	Pending
Application No.	Filing Date	Status Patented/Pending/Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following registered attorney(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

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I hereby authorize the above-named attorneys to accept and follow instructions from my Korean or United States representatives, Samsung Electronics, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the above-named attorneys and myself. In the event of a change in the persons from whom instructions may be taken, I will notify the above-named attorneys.

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